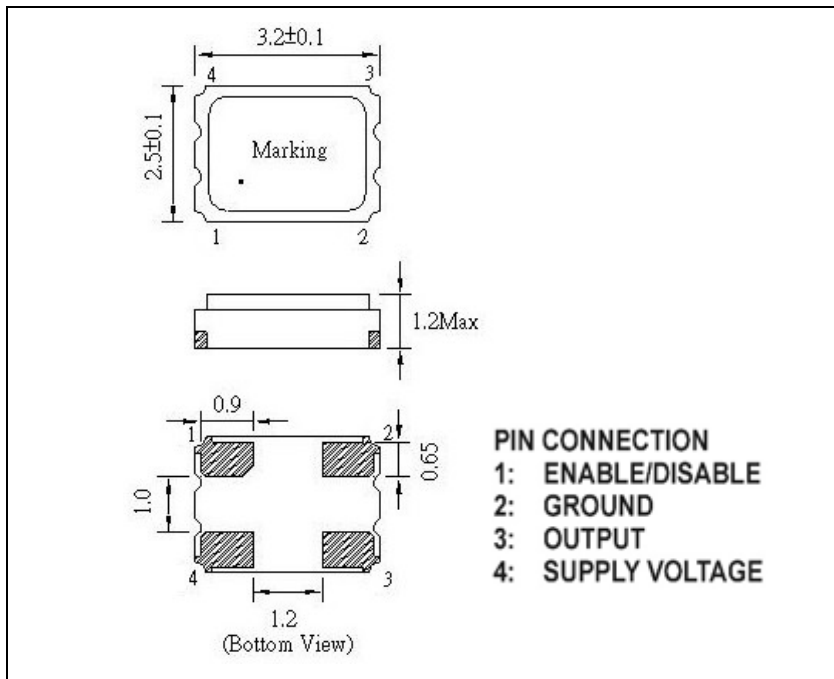


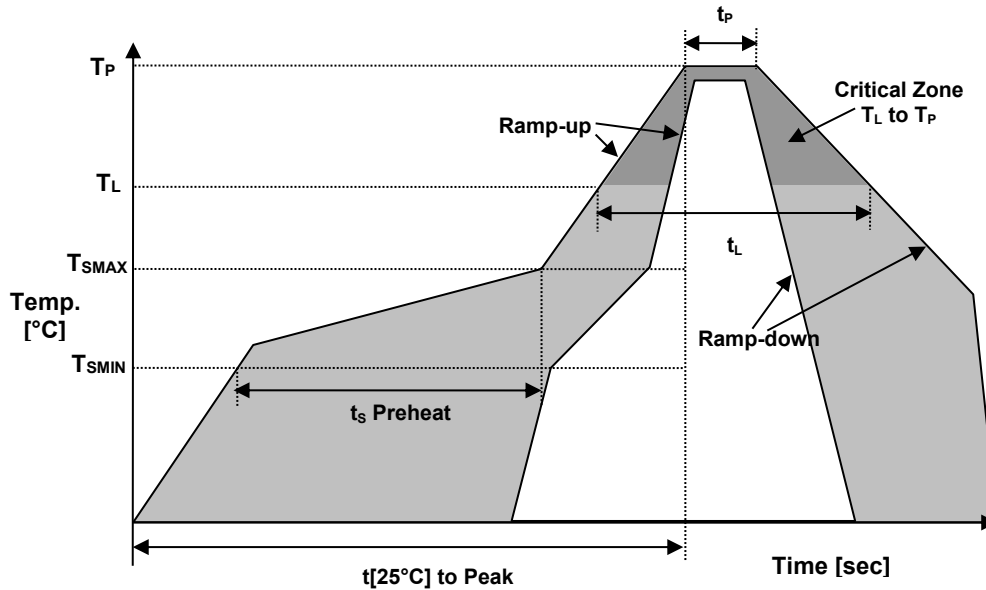
ELECTRICAL SPECIFICATION

PARAMETER	SYMBOL	CONDITIONS	VALUE	UNIT
Nominal Frequency	f_o	$T_a=25^{\circ}\text{C}$	27.000	MHz
Supply Voltage Range	V_{CC}	---	3.3	VDC
Operating Temperature Range	T_a	---	-40 ~ +85	$^{\circ}\text{C}$
Storage Temperature Range	$T_{(stg)}$	Absolute max	-55 ~ +125	$^{\circ}\text{C}$
Frequency Tolerance	$\Delta f/f_o$	Inclusive of 25°C Tolerance and Changes due to Operating Temperature, Supply Voltage, Load, Aging, Shock and Vibration	± 25	ppm
Output Voltage	V_{OL}	Logic "0" Level	$0.1 \times V_{CC}$	VDC
	V_{OH}	Logic "1" Level	$0.9 \times V_{CC}$	VDC
Output Load	---	CMOS Output	15	pF
Supply Current, max	I_s		40	mA
Enable / Disable Function	E/D	Pin 1: N.C. (Open) or High	Pin 3 – Oscillation (Enabled)	
		Pin 1: Low	Pin 3 – High Impedance (Disabled)	
Symmetry (Duty Cycle)	DC	@50% Vdd	45 to 55	%
Rise Time and Fall Time	t_r / t_f		10	ns

MECHANICAL SPECIFICATION



REFLOW PROFILE



Reflow profile		
Temperature Min Preheat	T_{SMIN}	150°C
Temperature Max Preheat	T_{SMAX}	200°C
Time (T_{SMIN} to T_{SMAX})	t_s	60-180 sec.
Temperature	T_L	217°C
Peak Temperature	T_P	260°C
Ramp-up rate	R_{UP}	3°C/sec max.
Ramp-down rate	R_{DOWN}	6°C/sec max.
Time within 5°C of Peak Temperature	t_p	10 sec.
Time $t_{[25^\circ\text{C}]}$ to Peak Temperature	$t_{[25^\circ\text{C}]}$ to Peak	480 sec.
Time	t_L	60-150 sec.

ENVIRONMENTAL

PARAMETER	VALUE
MOISTURE SENSITIVITY LEVEL	1
RoHS	COMPLIANT
REACH-SVHC	COMPLIANT
HALOGEN-FREE	COMPLIANT
TERMINATION FINISH	Au



MARKING

Rx27.0
•3AEyw

x – Internal Production ID code
y – Year code
w – Week code

YEAR CODE	
Year	Code
2011	1
2012	2
2013	3
2014	4
2015	5
2016	6
2017	7
2018	8
2019	9

ALPHA WEEK CODE TABLE					
Week	Code	Week	Code	Week	Code
1	a	19	s	37	K
2	b	20	t	38	L
3	c	21	u	39	M
4	d	22	v	40	N
5	e	23	w	41	O
6	f	24	x	42	P
7	g	25	y	43	Q
8	h	26	z	44	R
9	i	27	A	45	S
10	j	28	B	46	T
11	k	29	C	47	U
12	l	30	D	48	V
13	m	31	E	49	W
14	n	32	F	50	X
15	o	33	G	51	Y
16	p	34	H	52	Z
17	q	35	I		
18	r	36	J		

APPROVAL

RALTRON	
DRAWN BY:	AR, January 28, 2019
APPROVED BY:	CP, January 28, 2019
REVISION:	A, Initial Release